

FMUN2111 Thru FMUN2134

List

List.....	1
Package outline.....	2
Features.....	2
Mechanical data.....	2
Maximum ratings	2
Electrical characteristics.....	2~4
Rating and characteristic curves.....	5~13
Pinning information.....	14
Marking and Resistor values.....	14
Suggested solder pad layout.....	14
Packing Information.....	15
Reel packing.....	16
Suggested thermal profiles for soldering processes.....	16
High reliability test capabilities.....	17

FMUN2111 Thru FMUN2134

PNP Silicon Epitaxial Planar
Digital Transistor

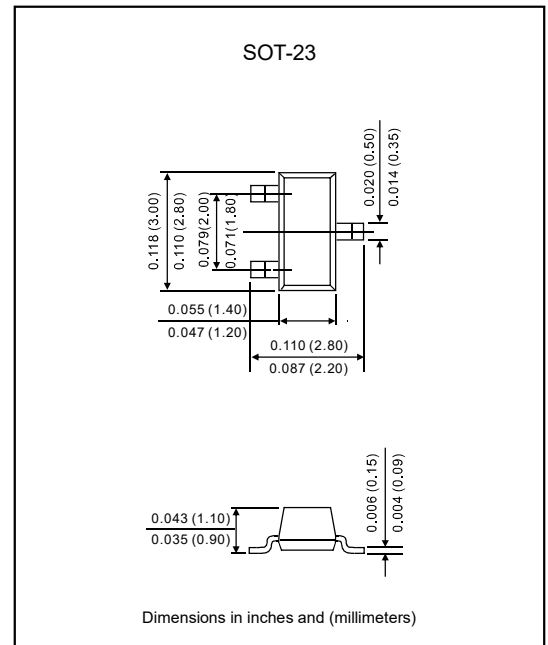
Features

- Simplifies circuit design.
- Reduces board space.
- Reduces component count.
- The SOT-23 package can be soldered using wave or reflow, the modified gull-winged leads absorb thermal stress during soldering eliminating the possibility of damage to the die.
- For switching and interface circuit and drive circuit applications.
- Lead-free parts meet RoHS requirements.
- Suffix "-H" indicates Halogen-free part, ex.FMUN2111-H.

Mechanical data

- Epoxy:UL94-V0 rated flame retardant.
- Case : Molded plastic, SOT-23.
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026.
- Mounting Position : Any.
- Weight : Approximated 0.008 gram.

Package outline

Maximum ratings (At $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Collector-base voltage	V_{CBO}	-50	V
Collector-emitter voltage	V_{CEO}	-50	V
Collector current	I_C	-100	mA
Total power dissipation	P_{tot}	200	mW
Operating junction temperature range	T_J	150	$^\circ\text{C}$
Storage temperature range	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical characteristics (At $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Conditions	Device	Symbol	Min.	Typ.	Max.	Unit
DC Current Gain	$-V_{CE}=10\text{V}, -I_C=5\text{mA}$	FMUN2111	h_{FE}	35			-
		FMUN2112		60			
		FMUN2113		80			
		FMUN2114		80			
		FMUN2115		160			
		FMUN2116		160			
		FMUN2130		3			
		FMUN2131		8			
		FMUN2132		15			
		FMUN2133		80			
		FMUN2134		80			

FMUN2111 Thru FMUN2134

Electrical characteristics (At $T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Conditions	Device	Symbol	Min.	Typ.	Max.	Unit
Collector-Base cutoff current	$-V_{CB}=50\text{V}$		$-I_{CBO}$			100	nA
Collector-Emitter cutoff current	$-V_{CE}=50\text{V}$		$-I_{CEO}$			500	nA
Emitter base cutoff current	$-V_{EB}=6\text{V}$	FMUN2111	$-I_{EBO}$			0.5	mA
		FMUN2112				0.2	
		FMUN2113				0.1	
		FMUN2114				0.2	
		FMUN2115				0.9	
		FMUN2116				1.9	
		FMUN2130				4.3	
		FMUN2131				2.3	
		FMUN2132				1.5	
		FMUN2133				0.18	
		FMUN2134				0.13	
Collector Base Breakdown Voltage	$-I_C=10\mu\text{A}$		$-V_{(BR)CBO}$	50			V
Collector Emitter Breakdown Voltage	$-I_C=2\text{mA}$		$-V_{(BR)CEO}$	50			V
Collector Emitter Saturation Voltage	$-I_C=10\text{mA}, -I_B=0.3\text{mA}$		$-V_{(CE)sat}$			0.25	V
	$-I_C=10\text{mA}, -I_B=5\text{mA}$	FMUN2130					
		FMUN2131					
	$-I_C=10\text{mA}, -I_B=1\text{mA}$	FMUN2115					
		FMUN2116					
		FMUN2132					
		FMUN2133					
		FMUN2134					
Output voltage(on)	$-V_{CC}=5\text{V}, -V_B=2.5\text{V}, R_L=1\text{K}\Omega$	FMUN2111	$-V_{OL}$			0.2	V
		FMUN2112					
		FMUN2114					
		FMUN2115					
		FMUN2116					
		FMUN2130					
		FMUN2131					
		FMUN2132					
		FMUN2133					
		FMUN2134					
	$-V_{CC}=5\text{V}, -V_B=3.5\text{V}, R_L=1\text{K}\Omega$	FMUN2113					

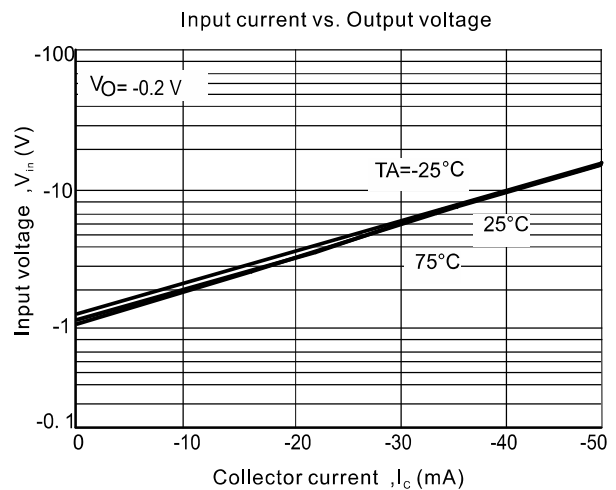
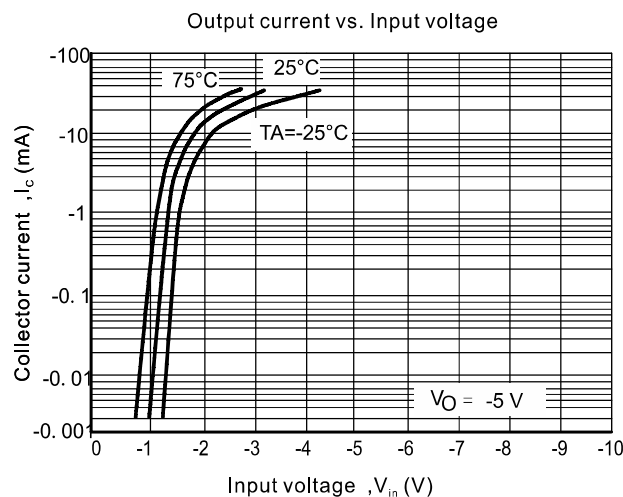
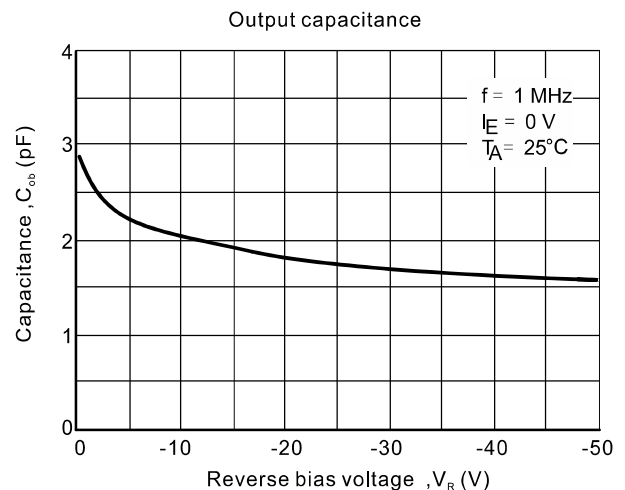
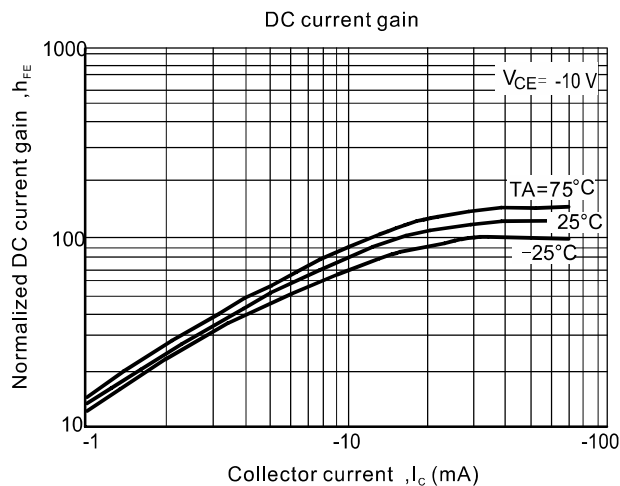
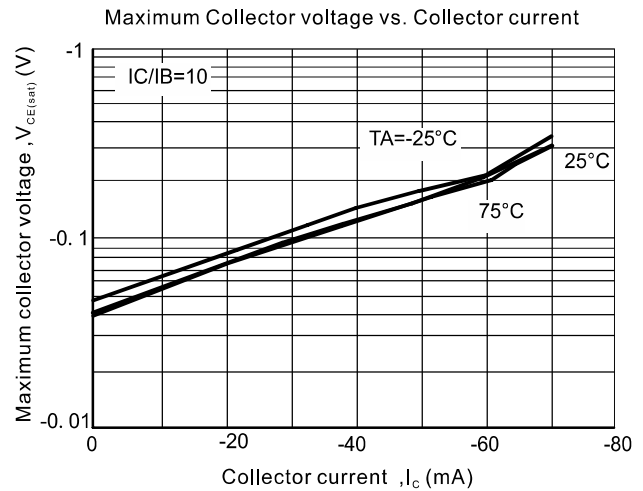
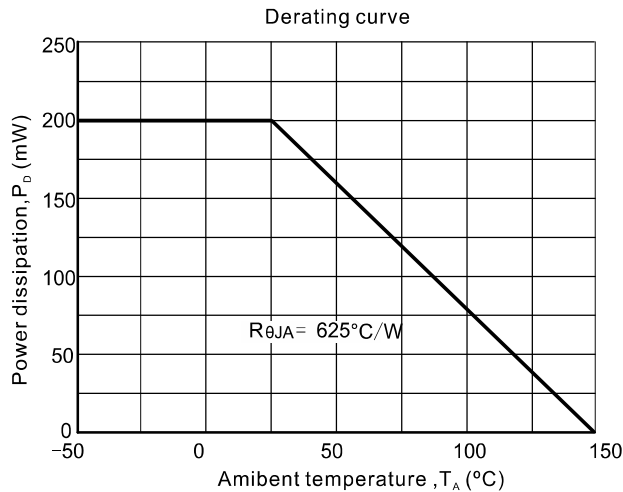
FMUN2111 Thru FMUN2134

Electrical characteristics (At $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Conditions	Device	Symbol	Min.	Typ.	Max.	Unit	
Output voltage(off)	$-V_{cc}=5V, -V_b=0.5V, R_L=1K\Omega$	FMUN2130	$-V_{OH}$	4.9			V	
	$-V_{cc}=5V, -V_b=0.05V, R_L=1K\Omega$	FMUN2115						
	$-V_{cc}=5V, -V_b=0.25V, R_L=1K\Omega$	FMUN2116						
		FMUN2131						
		FMUN2132						
lutput resistor		FMUN2111	R_1	7		13	K Ω	
		FMUN2112		15.4		28.6		
		FMUN2113		32.9		61.1		
		FMUN2114		7		13		
		FMUN2115		7		13		
		FMUN2116		3.3		6.1		
		FMUN2130		0.7		1.3		
		FMUN2131		1.5		2.9		
		FMUN2132		3.3		6.1		
		FMUN2133		3.3		6.1		
		FMUN2134		15.4		28.6		
Resistor ratio		FMUN2111	R_1/R_2	0.8		1.2	-	
		FMUN2112						
		FMUN2113						
		FMUN2114		0.17		0.25		
		FMUN2115		-	-	-		
		FMUN2116						
		FMUN2130		0.8		1.2		
		FMUN2131						
		FMUN2132						
		FMUN2133		0.055		0.185		

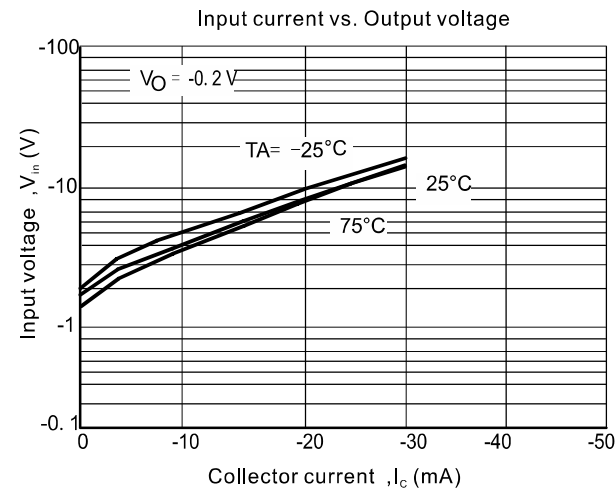
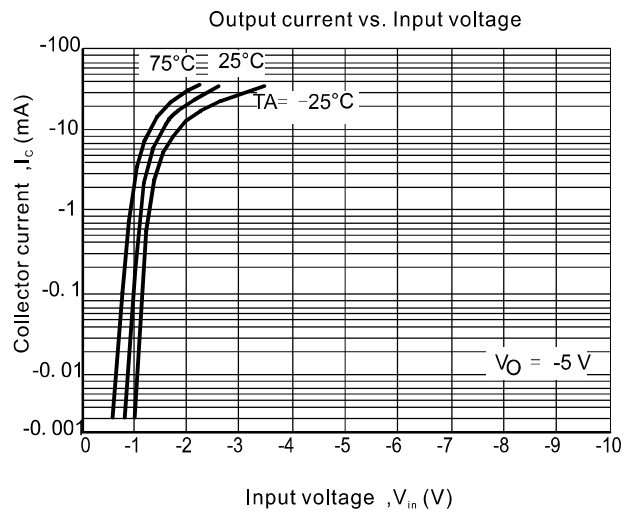
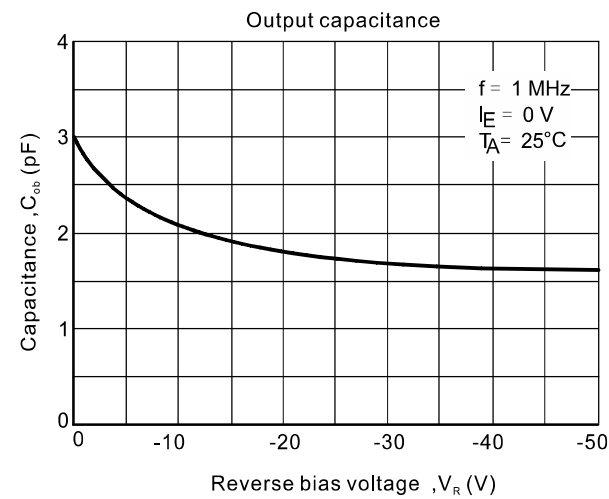
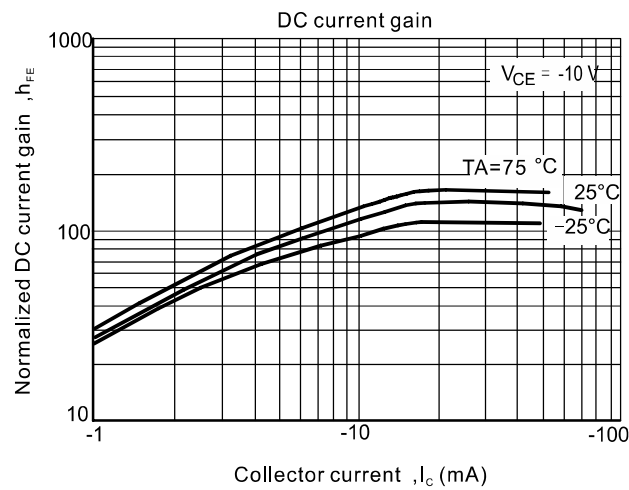
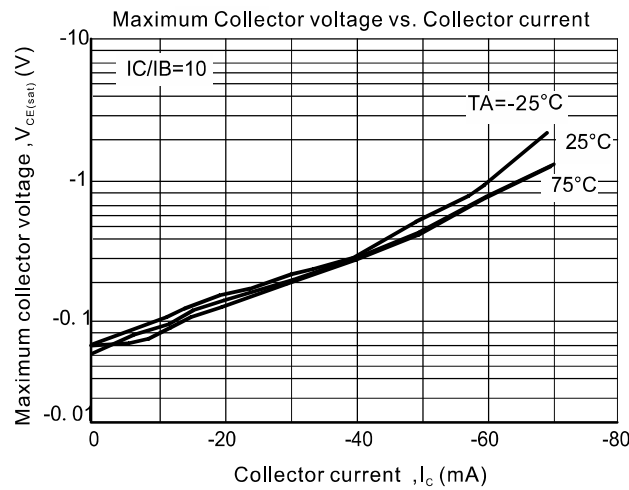
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2111)



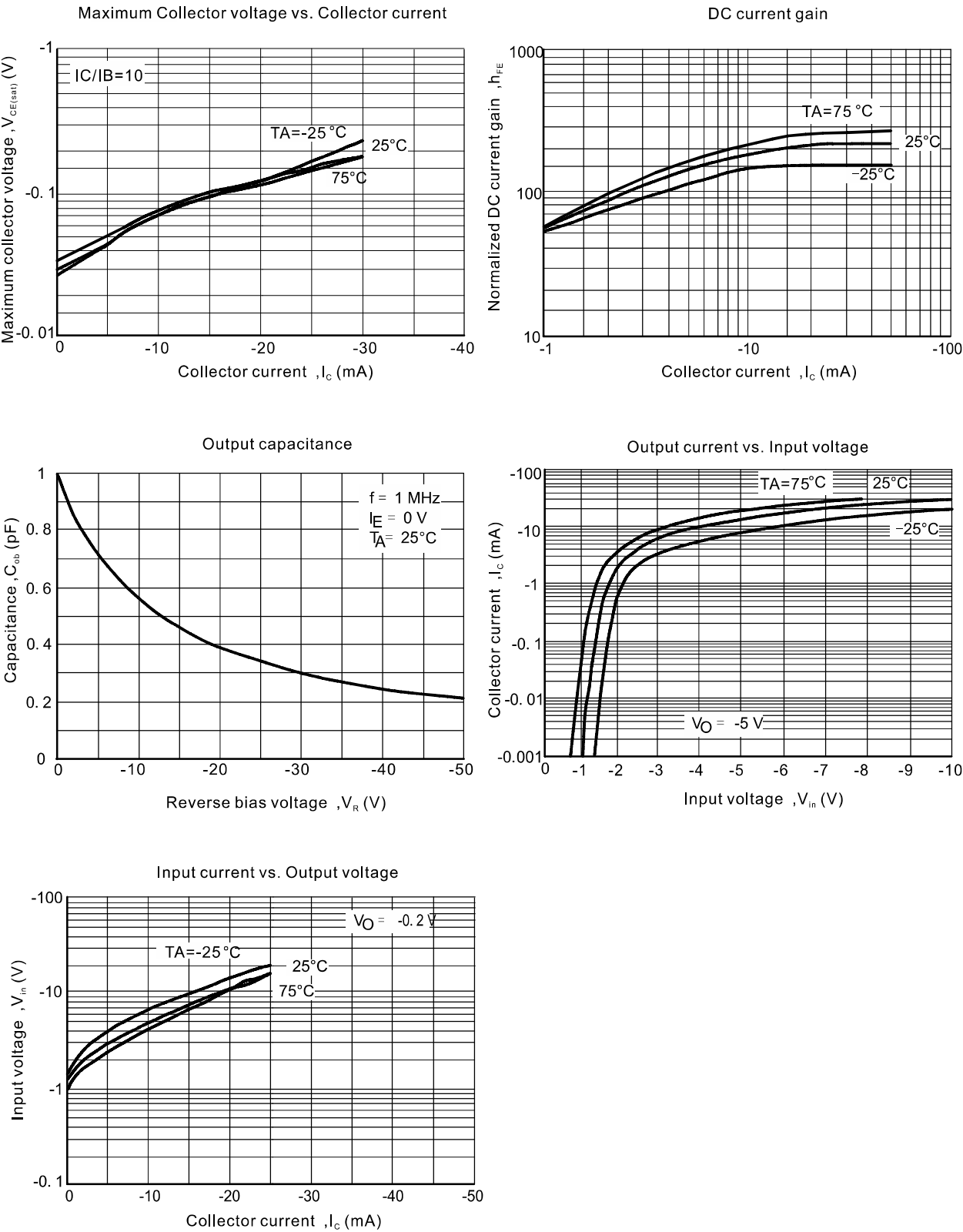
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2112)



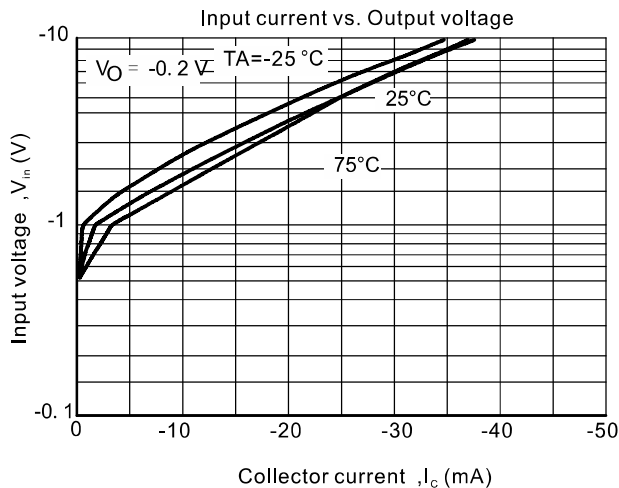
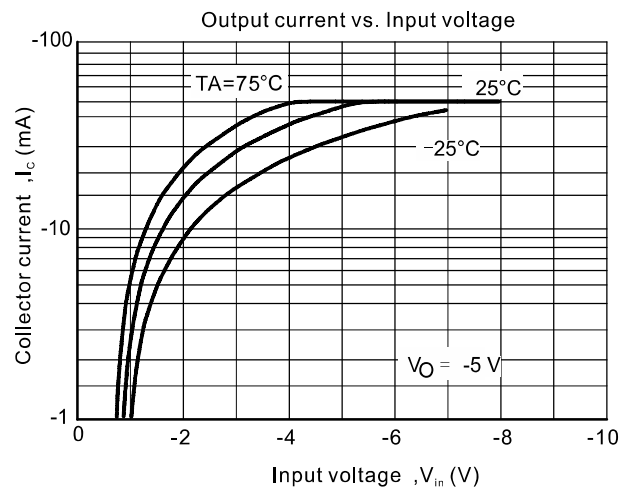
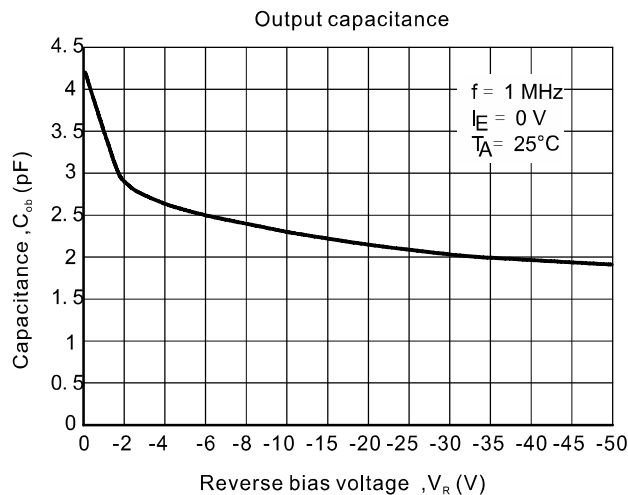
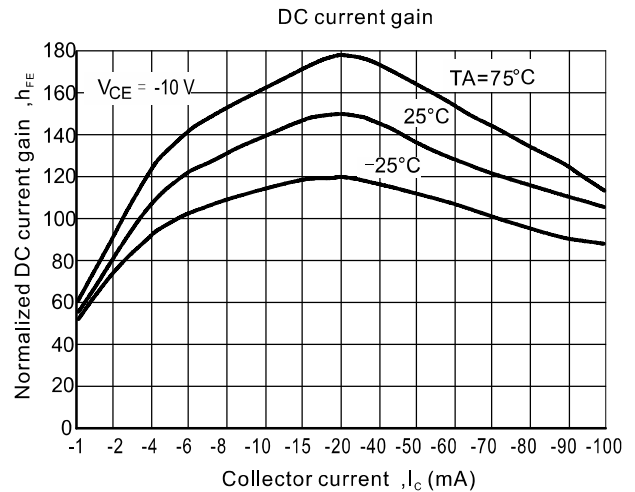
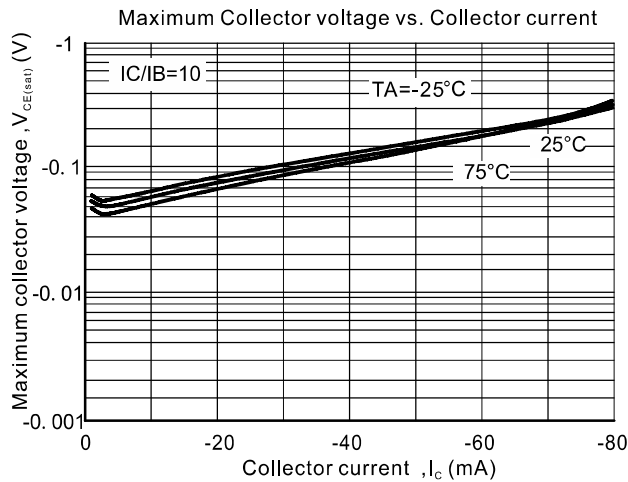
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2113)



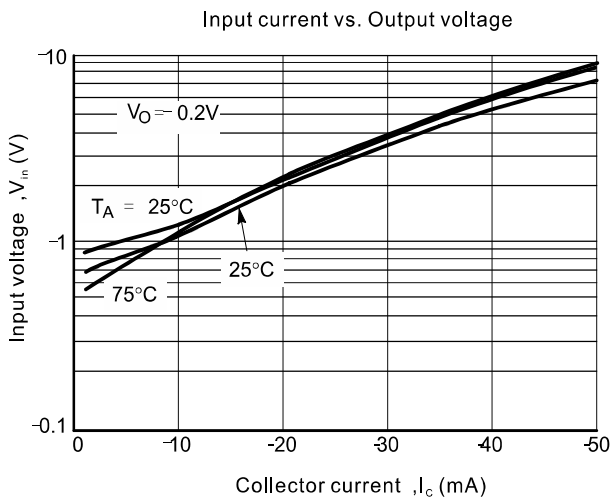
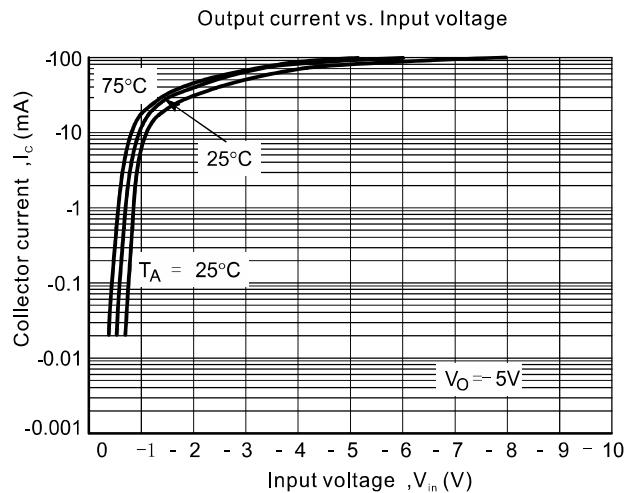
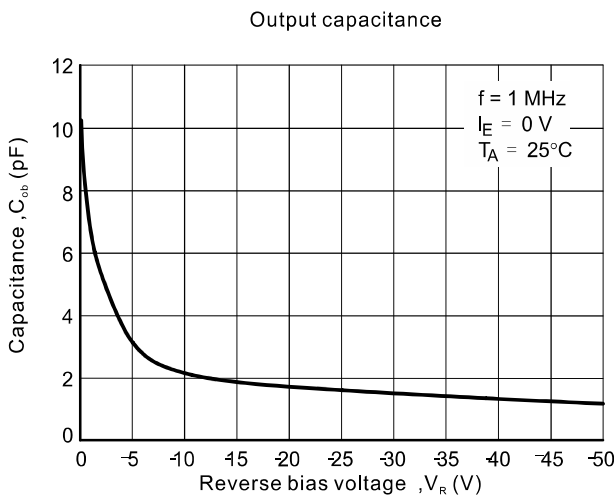
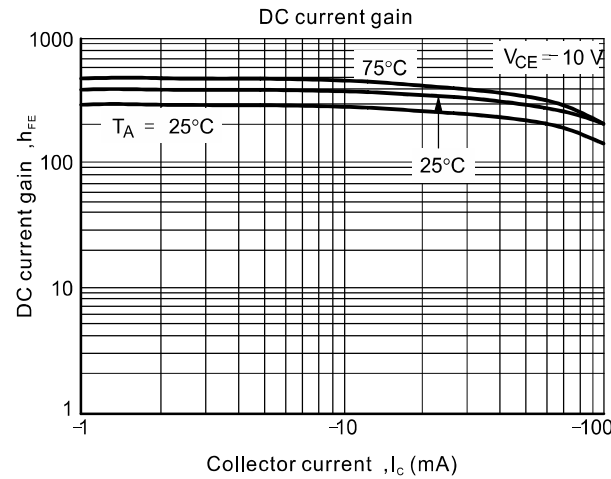
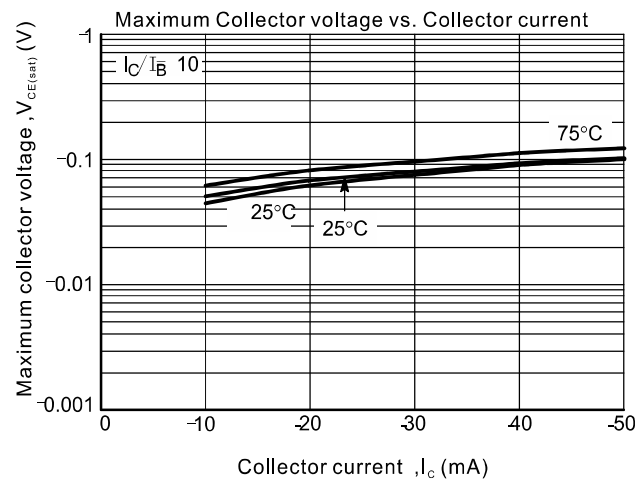
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2114)



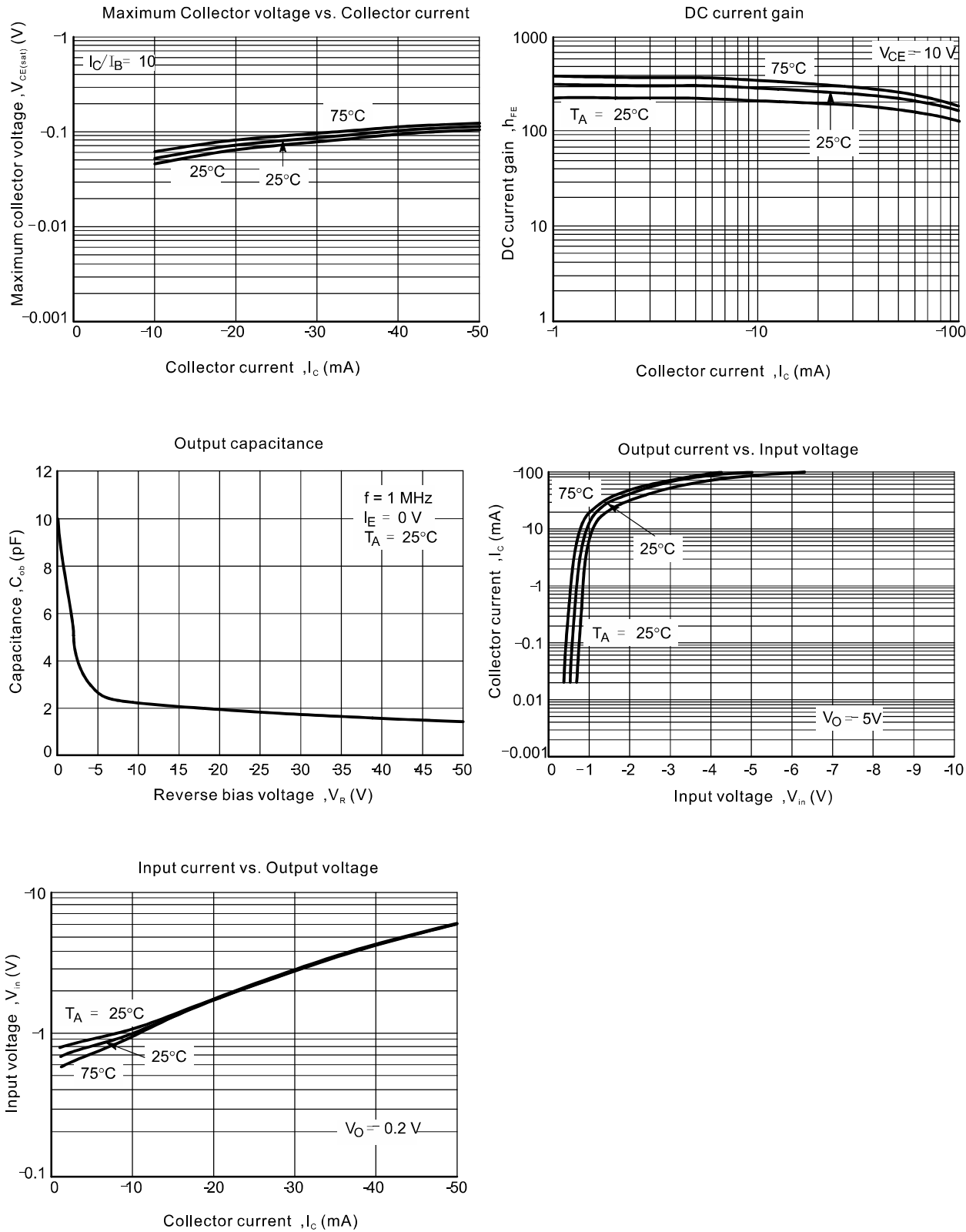
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2115)



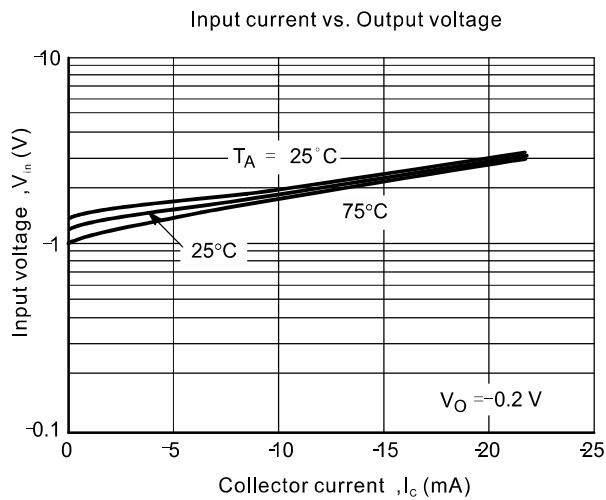
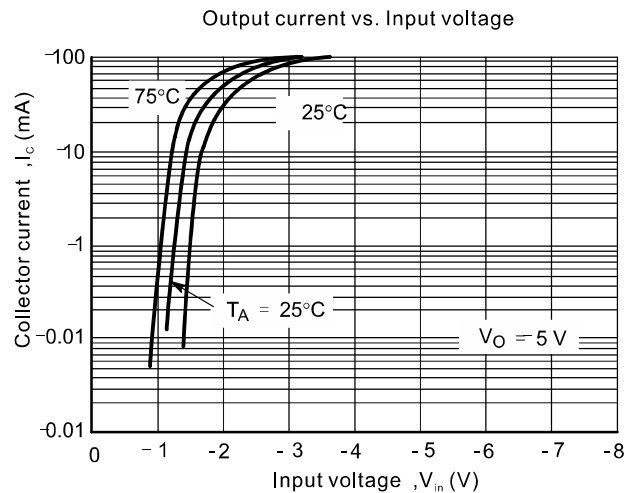
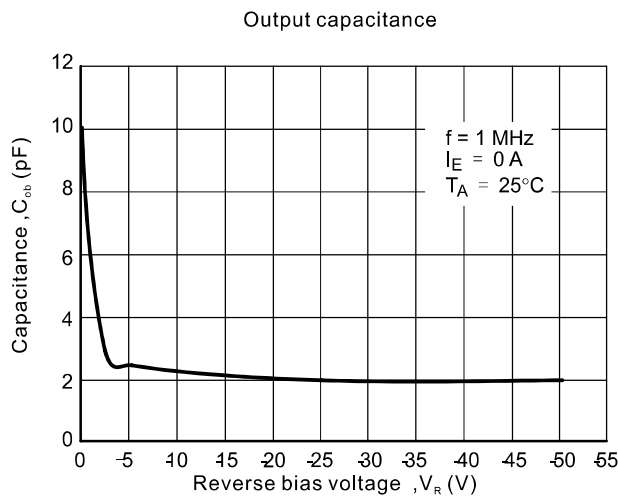
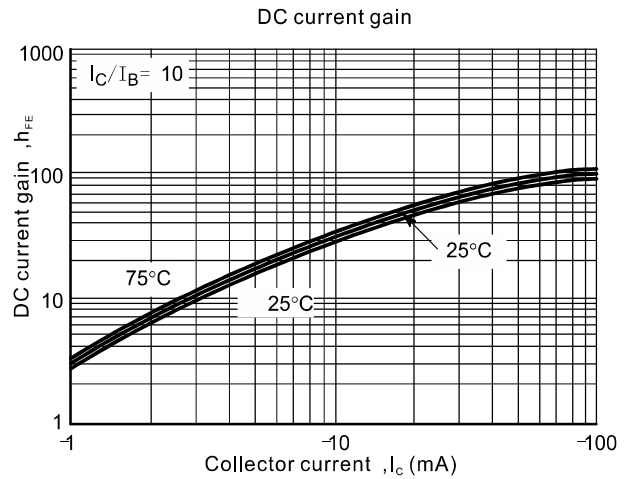
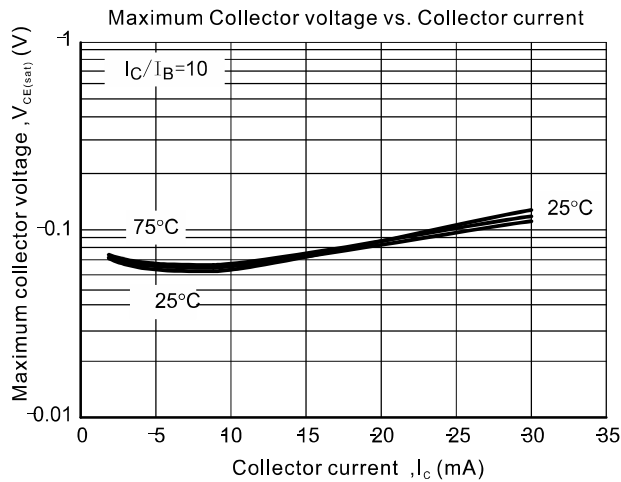
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2116)



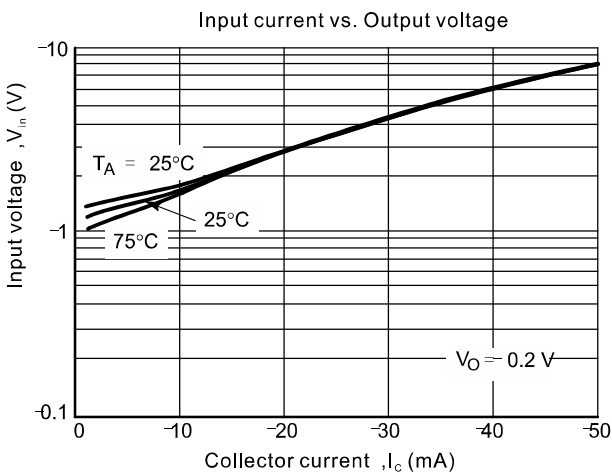
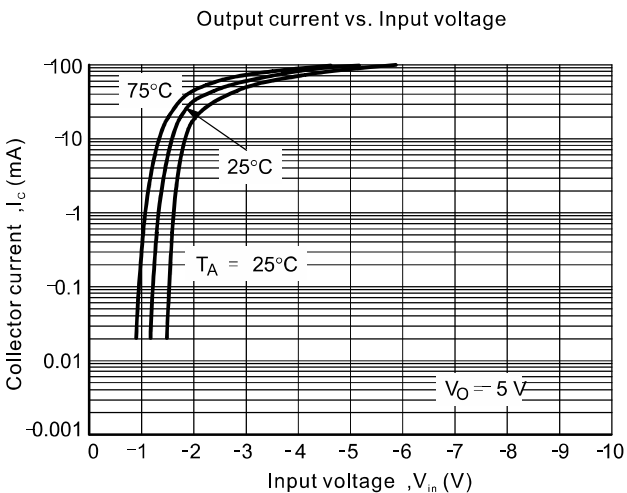
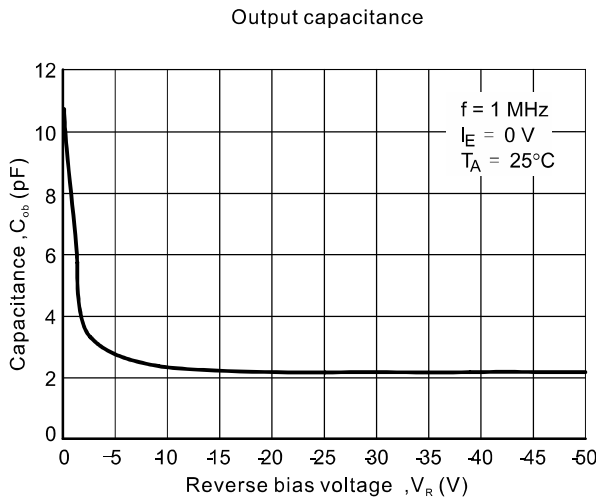
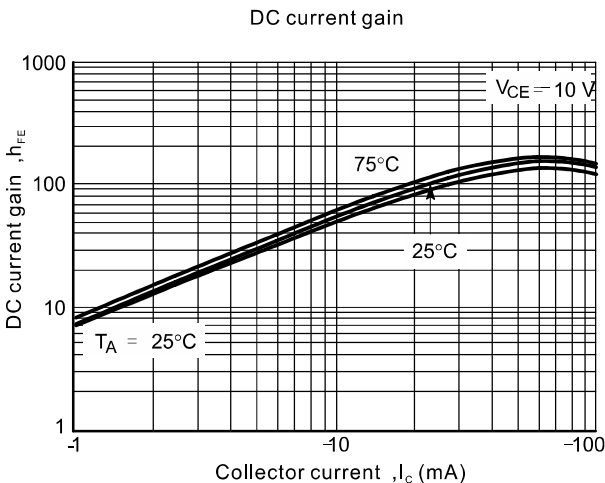
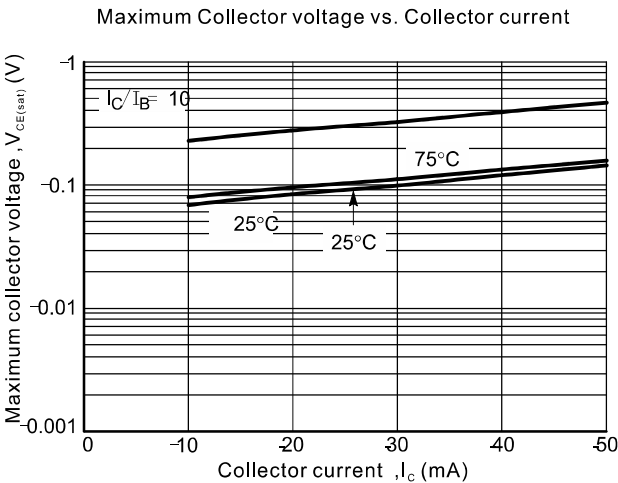
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2131)



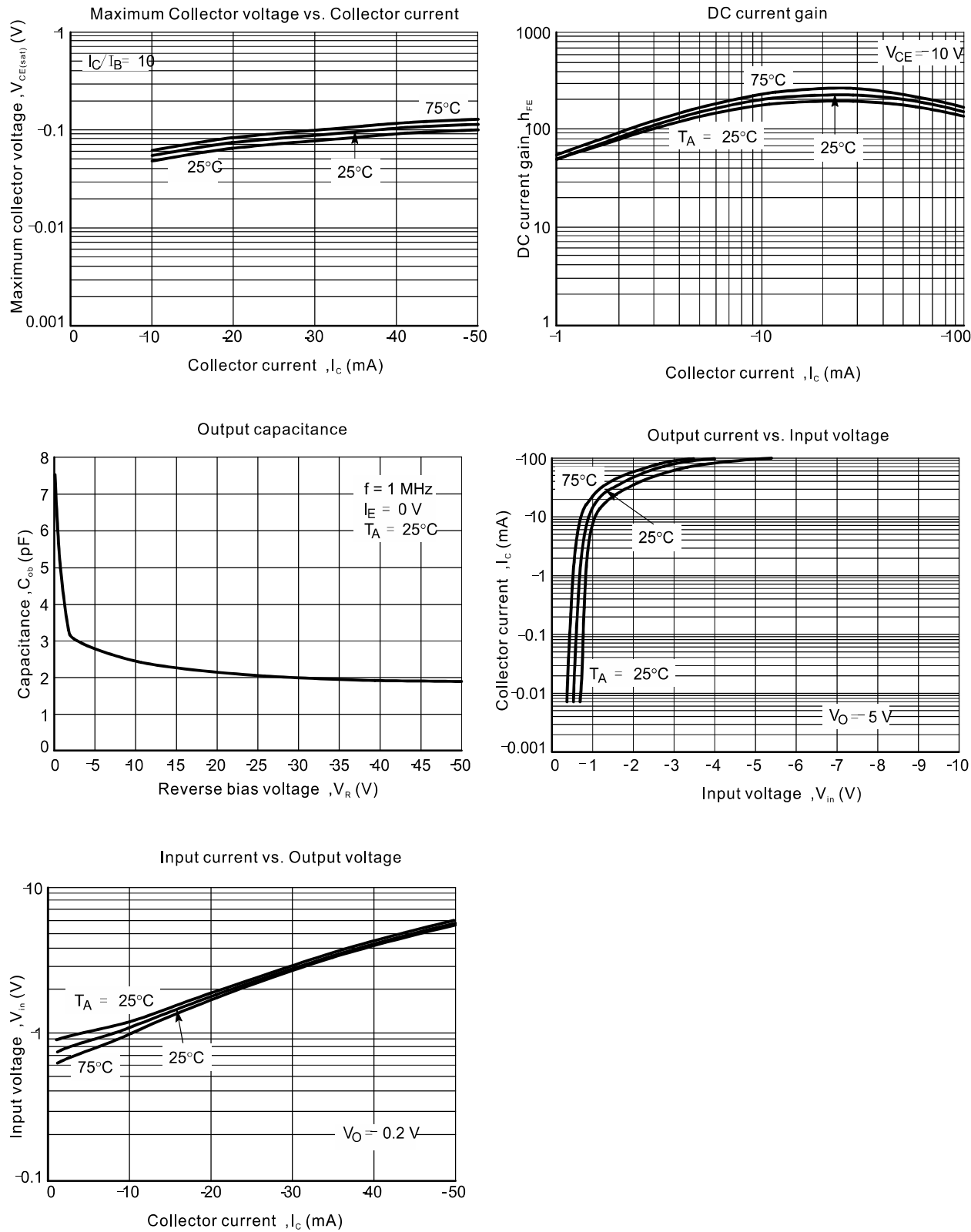
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2132)



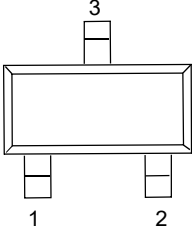
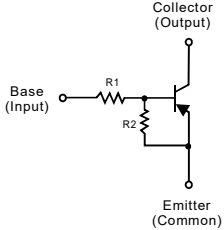
FMUN2111 Thru FMUN2134

Rating and characteristic curves (FMUN2133)



FMUN2111 Thru FMUN2134

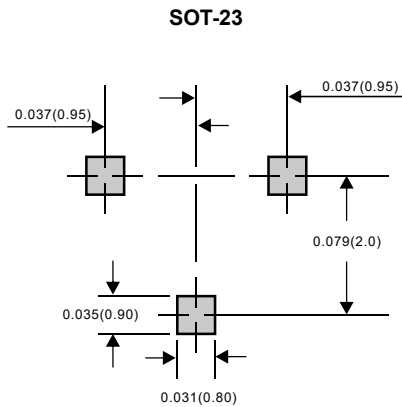
Pinning information

Pin	Simplified outline	Symbol
Pin 1 Base Pin 2 Emitter Pin 3 Collector		

Markingand and Resistor values

Type number	Marking code	R1(KΩ)	R2(KΩ)
FMUN2111	A6A	10	10
FMUN2112	A6B	22	22
FMUN2113	A6C	47	47
FMUN2114	A6D	10	47
FMUN2115	A6E	10	-
FMUN2116	A6F	4.7	-
FMUN2130	A6G	1	1
FMUN2131	A6H	2.2	2.2
FMUN2132	A6J	4.7	4.7
FMUN2133	A6K	4.7	47
FMUN2134	A6L	22	47

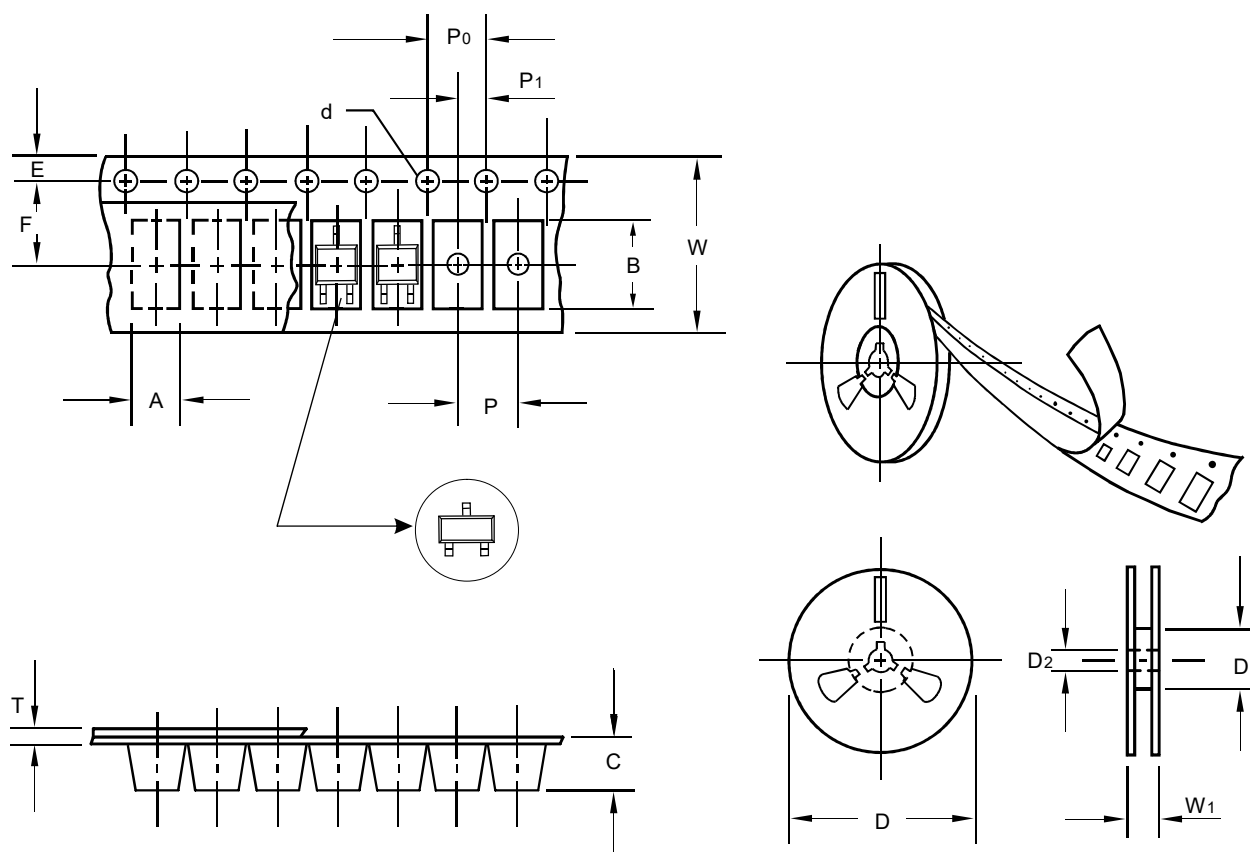
Suggested solder pad layout



Dimensions in inches and (millimeters)

FMUN2111 Thru FMUN2134

Packing information



unit:mm

Item	Symbol	Tolerance	SOT-23
Carrier width	A	0.1	3.15
Carrier length	B	0.1	2.77
Carrier depth	C	0.1	1.22
Sprocket hole	d	0.1	1.50
13" Reel outside diameter	D	2.0	-
13" Reel inner diameter	D1	min	-
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	min	54.40
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.23
Tape width	W	0.3	8.00
Reel width	W1	1.0	12.0

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

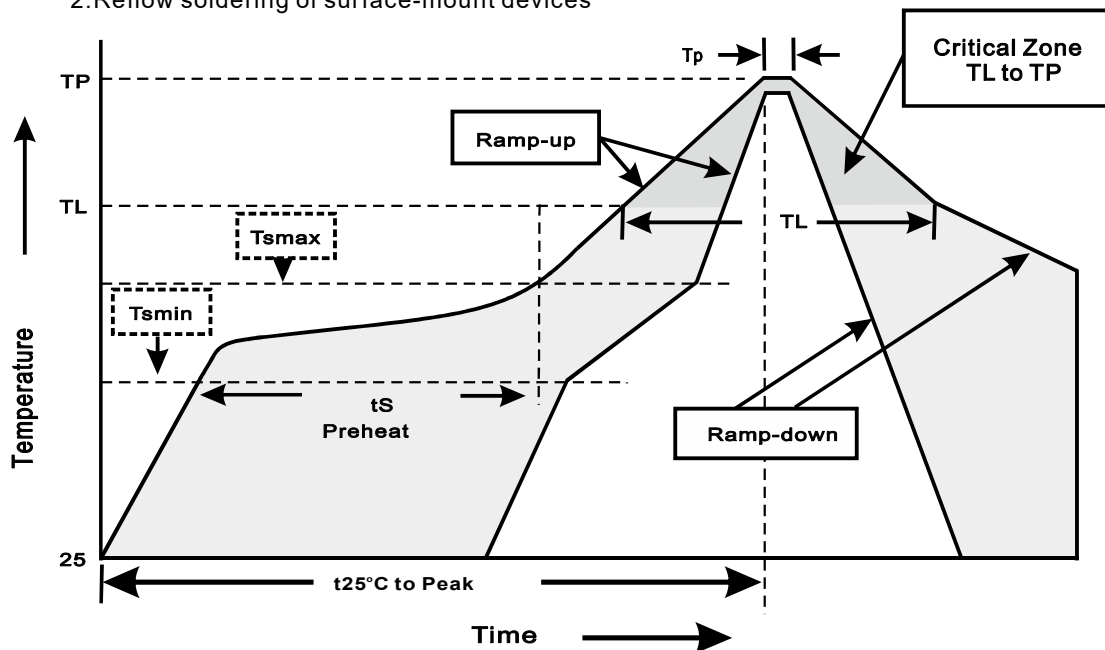
FMUN2111 Thru FMUN2134

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOT-23	7"	3,000	4.0	30,000	183*123*183	178	382*257*387	240,000	11.6

Suggested thermal profiles for soldering processes

- 1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%
- 2.Reflow soldering of surface-mount devices



3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T _L to T _P)	<3°C/sec
Preheat -Temperature Min(T _{min}) -Temperature Max(T _{max}) -Time(min to max)(t _s)	150°C 200°C 60~120sec
T _{max} to T _L -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(T _L) -Time(t _L)	217°C 60~260sec
Peak Temperature(T _P)	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t _P)	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes

FMUN2111 Thru FMUN2134

High reliability test capabilities

Item Test	Conditions
1. Steady State Operating Life	$P_D=246\text{mW}$ Test Duration:1000hrs
2. High Temperature Reverse Bias	$T_J=150^\circ\text{C}$, $V_{CE}=80\%$ related volage, 1000hrs
3. Temperature Cycle	$-55^\circ\text{C}(15\text{min})$ to $150^\circ\text{C}(15\text{min})$ Air to Air Transition Time<20sec Test Cycles: 1000cycle
4. Autoclave	$P=2\text{atm}$ $T_a=121^\circ\text{C}$ $RH=100\%$ Test Duration: 96hrs
5. High Temperature Storage Life	$T_a=150^\circ\text{C}$ Test Duration: 1000hrs
6. Solderability	245°C ,5sec
7. High Temperature High Humidity Reverse Bias	$T_a=85^\circ\text{C}$, 85%RH, $V_{CE}=80\%$ related volage, 1000hrs
8. Resistance to Soldering Heat	260°C ,10sec
10. Solvent Resistance	